

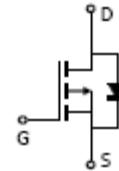


迈拓电子
MAITUO ELECTRONIC

MT2301T Plastic-Encapsulate MOSFETS

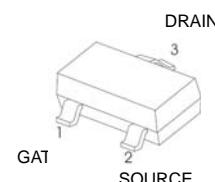
FEATURE

TrenchFET Power MOSFET



APPLICATIONS

- Load Switch for Portable Devices
- DC/DC Converter



MARKING: 2301

SOT-523

Maximum ratings ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 8	
Continuous Drain Current	I_D	-2.0	A
Pulsed Drain Current	I_{DM}	-6	
Continuous Source-Drain Diode Current	I_S	-0.72	
Maximum Power Dissipation	P_D	0.25	W
Thermal Resistance from Junction to Ambient($t \leq 5\text{s}$)	$R_{\theta JA}$	357	$^\circ\text{C}/\text{W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 ~+150	



迈拓电子
MAITUO ELECTRONIC

Electrical characteristics ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-20			V
Gate-source threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-0.4		-1	
Gate-source leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 8\text{V}$			± 100	nA
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Drain-source on-state resistance ^a	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -1.8\text{A}$		0.125	0.140	Ω
		$V_{\text{GS}} = -2.5\text{V}, I_{\text{D}} = -1.0\text{A}$		0.135	0.180	
Forward transconductance ^a	g_{fs}	$V_{\text{DS}} = -5\text{V}, I_{\text{D}} = -2.0\text{A}$		6.5		S
Dynamic^b						
Input capacitance	C_{iss}	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		405		pF
Output capacitance	C_{oss}			75		
Reverse transfer capacitance	C_{rss}			55		
Total gate charge	Q_g	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -3\text{A}$		5.5	10	nC
Gate-source charge	Q_{gs}			3.3	6	
Gate-drain charge	Q_{gd}			0.7		
Gate resistance	R_g			1.3		
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, R_L = 10\Omega, I_{\text{D}} = -1\text{A}, V_{\text{GEN}} = -4.5\text{V}, R_g = 1\Omega$		6.0		Ω
Rise time	t_r			11	20	ns
Turn-off delay time	$t_{\text{d}(\text{off})}$			35	60	
Fall time	t_f			30	50	
Drain-source body diode characteristics						
Continuous source-drain diode current	I_s	$T_c = 25^\circ\text{C}$			-1.3	A
Pulse diode forward current ^a	I_{SM}				-10	
Body diode voltage	V_{SD}	$I_s = -0.7\text{A}$		-0.8	-1.2	V

Notes :

a.Pulse Test : Pulse Width < 300μs, Duty Cycle ≤2%.

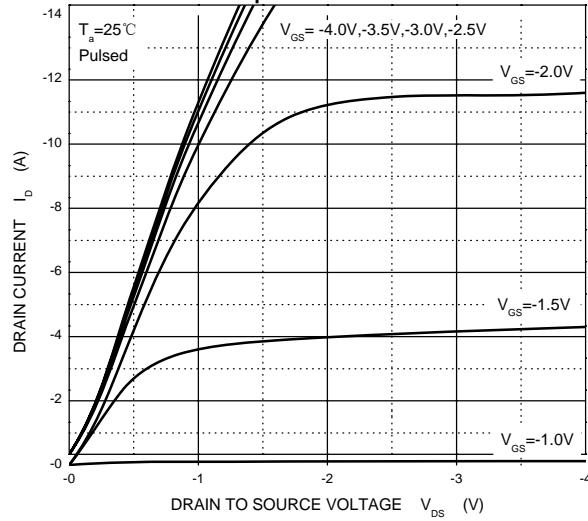
b.Guaranteed by design, not subject to production testing.



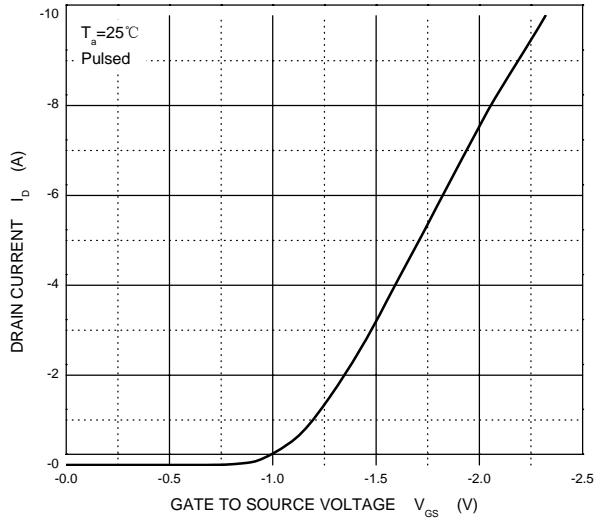
迈拓电子
MAITUO ELECTRONIC

Typical Characteristics

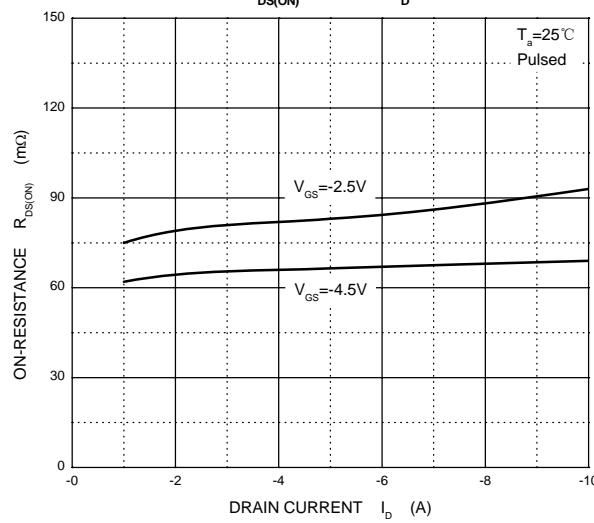
Output Characteristics



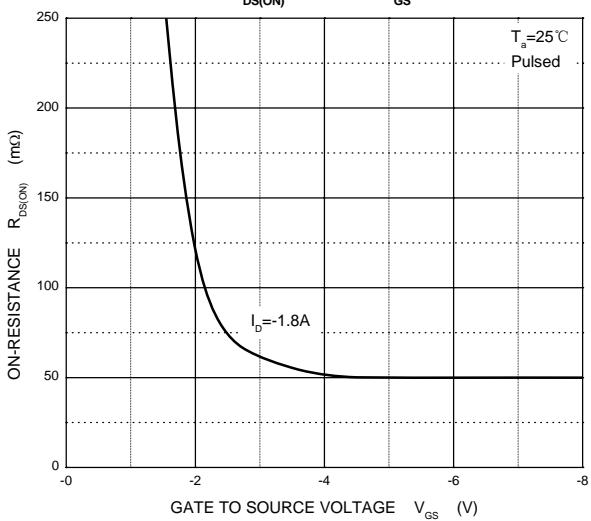
Transfer Characteristics



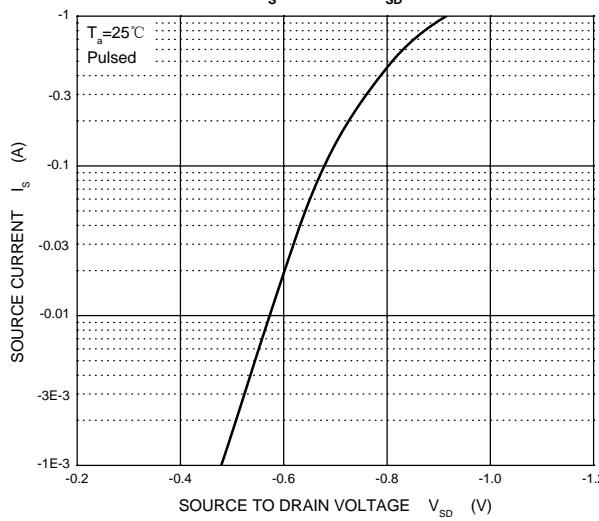
$R_{DS(ON)}$ — I_D



$R_{DS(ON)}$ — V_{GS}



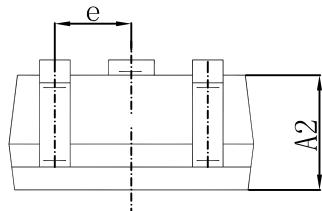
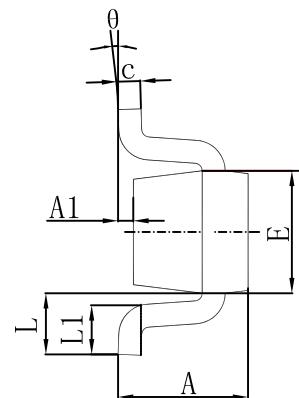
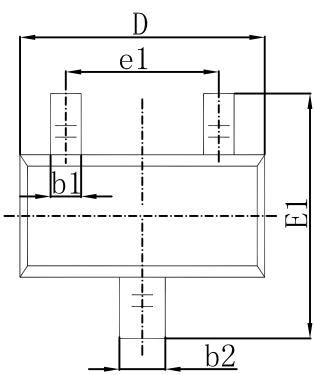
I_S — V_{SD}





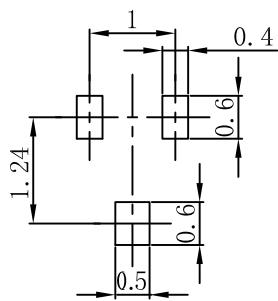
迈拓电子
MAITUO ELECTRONIC

SOT-523 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

SOT-523 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.